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SERIAL NUMBER 10/693,217	FILING DATE 10/24/2003  RULE	CLASS 438	GROUP ART UNIT 2811	ATTORNEY DOCKET NO. 27-035.D1
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## APPLICANTS

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## \*\* CONTINUING DATA \*\*\*\*\*

This application is a DIV of 09/640,534 08/17/2000 PAT 6,660,565 *DLO*\*\* FOREIGN APPLICATIONS \*\*\*\*\* *DLO*

## IF REQUIRED, FOREIGN FILING LICENSE GRANTED

\*\* 01/23/2004

Foreign Priority claimed <input type="checkbox"/> yes <input checked="" type="checkbox"/> no	STATE OR	SHEETS	TOTAL	INDEPENDENT
35 USC 119 (a-d) conditions met <input type="checkbox"/> yes <input checked="" type="checkbox"/> no <input type="checkbox"/> Met after Allowance	COUNTRY	DRAWING	CLAIMS	CLAIMS
Verified and Acknowledged Examiner's Signature <i>DLO</i> Initials <i>DLO</i>	SINGAPORE	2	10	2

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## TITLE

Flip chip molded/exposed die process and package structure

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